PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ZHUOFAN CHEN	10/30/2017
YIBIN SONG	10/30/2017
HAIYANG ZHANG	10/30/2017

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL (SHANGHAI) CORPORATION
Street Address:	18 ZHANGJIANG ROAD, PUDONG NEW AREA
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	201203
Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION
Street Address:	18 WENCHANG ROAD
Internal Address:	BEIJING ECONOMIC-TECHNOLOGICAL DEVELOPMENT AREA
City:	BEIJING
State/Country:	CHINA
Postal Code:	100176

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15799915

CORRESPONDENCE DATA

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SIGNATURE:	/Jing Zheng/
DATE SIGNED:	10/31/2017

Total Attachments: 2
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ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

Zhuofan CHEN	of	18 Zhangjiang Road Pudong New Area Shanghai, P.R.C. 201203
Yibin SONG	of	18 Zhangjiang Road Pudong New Area Shanghai, P.R.C. 201203
Haiyang ZHANG	of	18 Zhangjiang Road Pudong New Area Shanghai, P.R.C. 201203

hereby sell, assign and transfer to **Semiconductor Manufacturing International (Shanghai) Corporation**, having a place of business at 18 Zhangjiang Road, Pudong New Area, Shanghai, P.R.C. 201203, and, **Semiconductor Manufacturing International (Beijing) Corporation**, having a place of business at 18 Wenchang Road, Beijing Economic-Technological Development Area, Beijing, China, 100176, its successors and assigns, the entire right, title and interest throughout the world in the invention entitled

A MAGNETIC RANDOM ACCESS MEMORY AND MANUFACTURE THEREOF

for which we have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisionals, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 30th day of _____ Oct. _____, 2017.

_____
Zhuofan CHEN

WITNESSED:
_____
Signature

Rong yao Chong
_____
Date
2017 – 10 – 30
_____
Type or print name of witness

Executed this 30th day of _____ Oct. _____, 2017.

Yibin Song
Yibin SONG

WITNESSED: 郭二崖

Signature

Erhu Zheng

Date

_2017.10.30._

Type or print name of witness

Executed this 30th day of _____ Oct. _____, 2017.

Haoyang Zhang
Haiyang ZHANG

WITNESSED: 张翠菜

Signature

Yi ying Zhang

Date

_2017.10.30_

Type or print name of witness